

Sliver for SFF-TA-1002

TE Internal #: 2340326-1

Sliver for SFF-TA-1002, PCB Edge Card, Straddle Mount, 84 Position, Surface Mount, Sliver for SFF-TA-1002, Internal I/O

Connectors

View on TE.com >

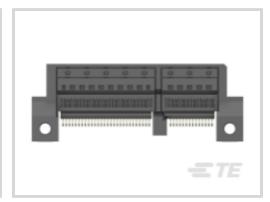


Connectors > PCB Connectors > Internal I/O Connectors











Internal I/O Connector Type: Sliver for SFF-TA-1002

Connector Mates With: PCB Edge Card
PCB Mount Orientation: Straddle Mount

Number of Positions: 84

Industry Standard: Gen-Z, OCP NIC 3.0

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Internal I/O Connector Type	Sliver for SFF-TA-1002
Connector Mates With	PCB Edge Card

Configuration Features

Number of Rows	2
PCB Mount Orientation	Straddle Mount
Number of Positions	84

Contact Features

PCB Contact Termination Area Plating Material	Tin
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Gold (Au)
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	1.1 A
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]



Termination Features

Termination Method to PCB	Surface Mount
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.6 mm[.023 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Industry Standard	Gen-Z, OCP NIC 3.0

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

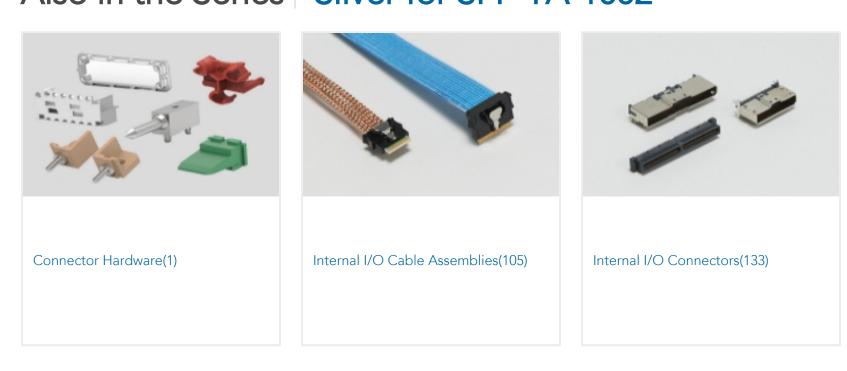


on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

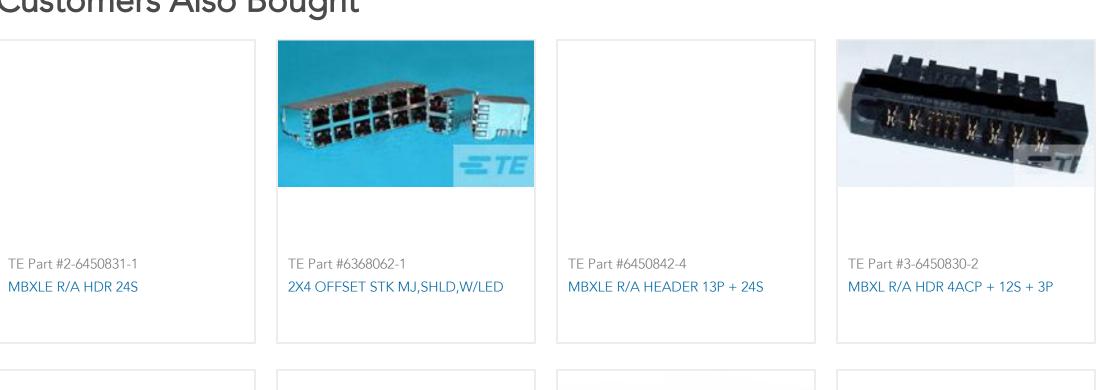
Compatible Parts



Also in the Series | Sliver for SFF-TA-1002



Customers Also Bought















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2340326-1_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2340326-1_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2340326-1_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Sliver Internal Cabled Interconnect Solutions Brochure (Chinese)

Product Specifications

Application Specification

English

Application Specification

English

Agency Approvals

UL Report

English